

MAAL-011158-DIE

Rev. V3

Features

- Phase Noise: -172 dBc/Hz @ 10 kHz
- Gain: 12 dB
- P_{SAT}: +24 dBm
- Bias Voltage: V_{CC} = +6 V
- Bias Current: I_{CQ} = 135 mA
- 50 Ω Matched Input and Output
- Positive Voltage Only
- Die Size: 3000 x 1300 x 100 µm
- RoHS* Compliant

Applications

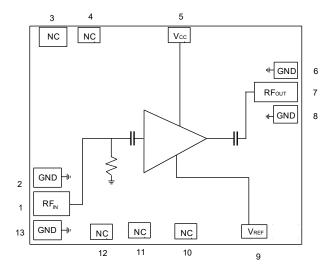
- Radar
- Electronic Countermeasures
- Test and Measurement
- Microwave Communication Systems

Description

The MAAL-011158-DIE is an easy to use low phase noise amplifier chip. It operates from 2 - 28 GHz and provides -172 dBc/Hz phase noise, 12 dB gain and +24 dBm P_{SAT} . The input and output are fully matched to 50 Ω with typical return loss >14 dB.

This product is fabricated using a GaAs HBT process which features full passivation for enhanced reliability.

Functional Schematic



Pad Configuration¹

Pad #	Pad Name	Description
2,6,8,13	GND	DC + RF Ground to Backside Via
1	RF _{IN}	RF Input
3,4,10,11,12	NC	Not Connected
5	V _{CC}	Supply Voltage
7	RF _{OUT}	RF Output
9	V _{REF}	Reference Voltage

1. Backside of die must be connected to RF, DC and thermal ground.

Ordering Information

Part Number	Package	
MAAL-011158-DIE	Gel Pack	

* Restrictions on Hazardous Substances, compliant to current RoHS EU directive.

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Electrical Specifications: Freq. = 2 - 28 GHz, T_A = +25°C, V_{CC} = 6 V, Z_0 = 50 Ω (Based on probed die production data)

Parameter	Test Conditions	Units	Min.	Тур.	Max.
Gain	P _{IN} = -10 dBm, 6 GHz P _{IN} = -10 dBm, 18 GHz P _{IN} = -10 dBm, 28 GHz	dB	10 10 8	12 12 10	
Gain Flatness		dB	—	±1	
Gain Variation over Temperature		dB/°C	—	0.011	—
Output Power	P _{IN} = +13 dBm, 6 GHz P _{IN} = +10 dBm, 18 GHz P _{IN} = +8.5 dBm, 28 GHz	dBm	22 19 15	24 21 17.5	_
Noise Figure		dB	_	4.0	—
Input Return Loss		dB	_	15	
Output Return Loss		dB		14	_
P1dB	16 GHz	dBm		22	
P _{SAT}	16 GHz	dBm	_	25	_
OIP3	16 GHz, -10 dBm P _{IN} per tone	dBm		32.5	
Phase Noise	10 GHz, Psat 100 Hz 1 kHz 10 kHz 1 MHz	dBc/Hz	_	-148 -164 -172 -178	
lcq	—	mA		135	

Absolute Maximum Ratings^{2,3}

Parameter	Absolute Maximum	
Input Power	19 dBm	
V _{CC}	7.5 V	
I _{CC}	350 mA	
Junction Temperature ^{4,5}	+130°C	
Operating Temperature	-40°C to +85°C	
Storage Temperature	-65°C to +125°C	

2. Exceeding any one or combination of these limits may cause permanent damage to this device.

- 3. MACOM does not recommend sustained operation near these survivability limits.
- Operating at nominal conditions with T_J ≤ +130°C will ensure MTTF > 1 x 10⁶ hours.
- 5. Junction Temperature $(T_J) = T_C + \Theta jc^* (V^* I)$ Typical thermal resistance $(\Theta jc) = 16.4 \text{ °C/W}$. a) For $T_C = +25^\circ\text{C}$, $T_J = 59.4^\circ\text{C}$ @ 7.5 V, 280 mA b) For $T_C = +85^\circ\text{C}$, $T_J = 119.4^\circ\text{C}$ @ 7.5 V, 280 mA

Maximum Operating Conditions

Parameter	Maximum	
Input Power	17 dBm	
V _{CC}	7 V	
I _{CC}	280 mA	
Junction Temperature	+130°C	
Operating Temperature	-40°C to +85°C	
Storage Temperature	-65°C to +125°C	

Handling Procedures

Please observe the following precautions to avoid damage:

Static Sensitivity

These electronic devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these HBM Class 1A, 250 V devices.

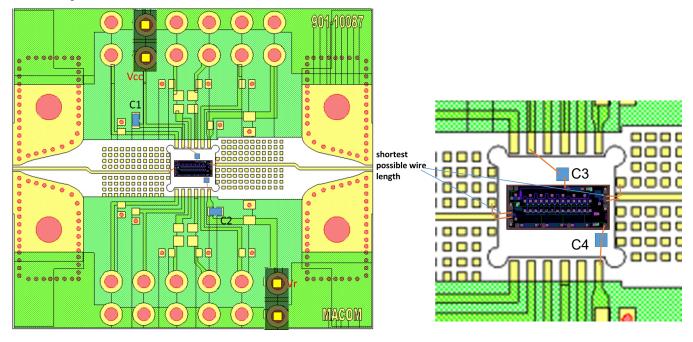
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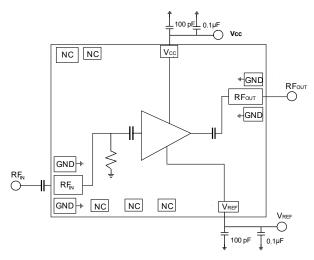
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PCB Layout



Application Schematic



Operation

To turn-on:

- 1. Apply +6 V to V_{CC}
- 2. Starting at 0 V, adjust V_{REF} for target I_{CC} (+2 V typical)
- To turn-off:
- 1. Set V_{REF} to 0 V
- 2. Set V_{CC} to 0 V

Evaluation PCB Specifications

Top Layer: 1/2 oz Copper Cladding, 0.017 mm thickness *Dielectric Layer:* Rogers RO4350B 0.101 mm thickness *Bottom Layer:* 1/2 oz Copper Cladding, 0.017 mm thickness *Finished overall thickness:* 0.135 mm

Parts List

Part	Value	Case Style	MFG	MFG Part #
C3, C4	100 pF	Single Layer	МАСОМ	MKVC-050100-1453
C1, C2	0.1 µF	0402	KYOCERA	04023C103KAT2A

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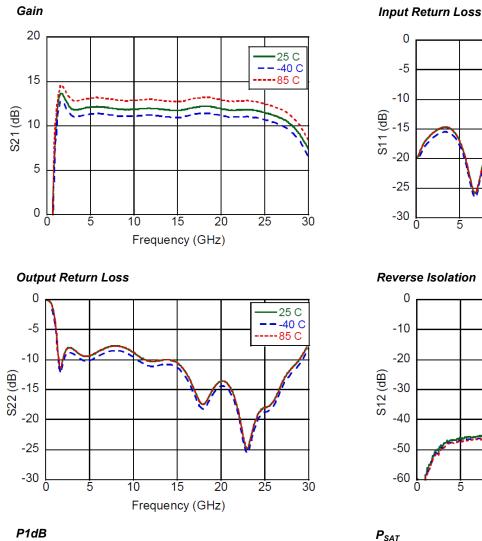
25 C

- - -40 C

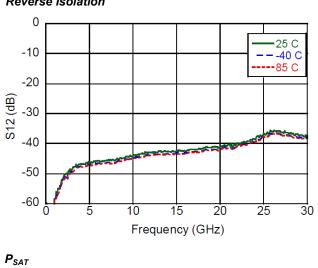
----85 C

25

30



Typical Performance Curves: $V_{cc} = 6 V$, $I_{cc} = 135 mA$



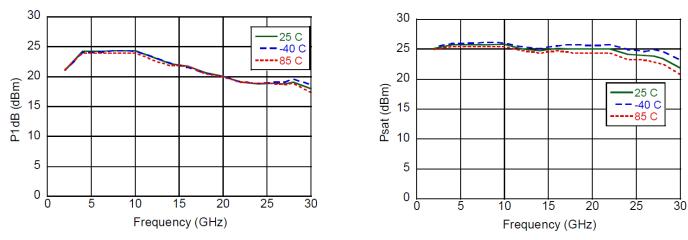
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10

15

Frequency (GHz)

20



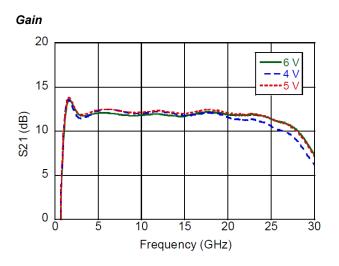
4

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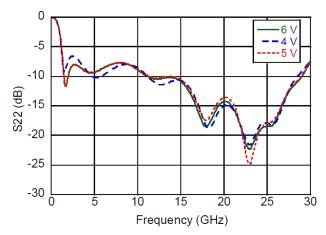


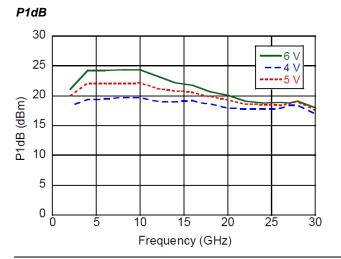
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Typical Performance Curves: I_{cc} = 135 mA, +25°C

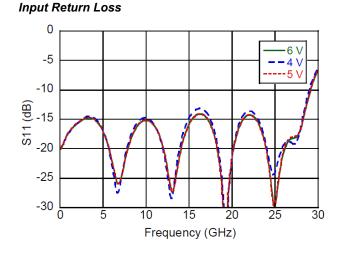


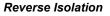
Output Return Loss

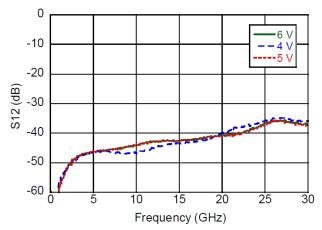


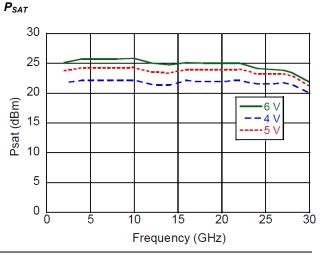








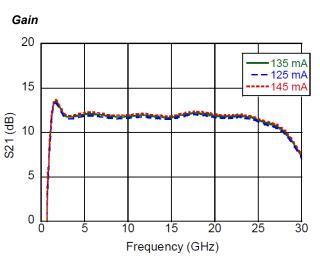




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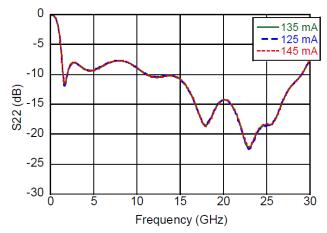


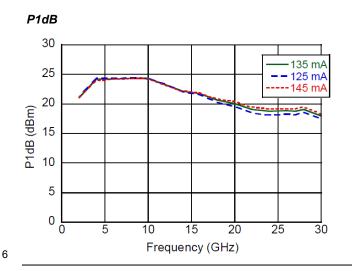
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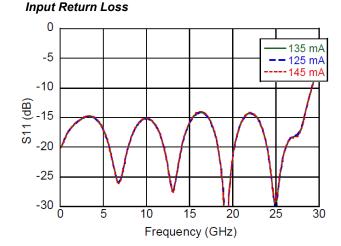


Typical Performance Curves: V_{cc} = 6 V, +25°C

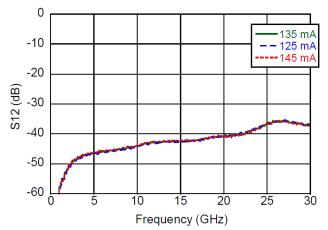
Output Return Loss

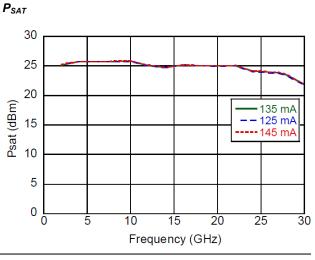






Reverse Isolation





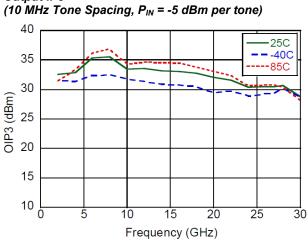
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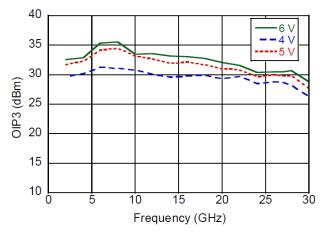
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Typical Performance Curves: V_{cc} = 6 V, I_{cc} = 135 mA, +25°C

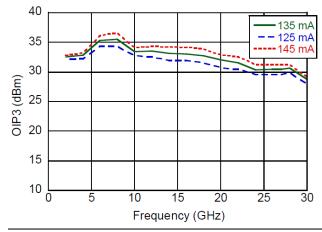
Output IP3

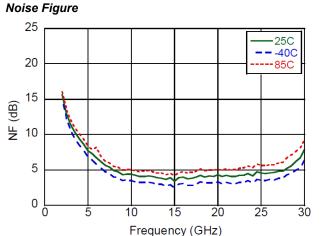


Output IP3 (10 MHz Tone Spacing, $P_{IN} = -5 \text{ dBm per tone}$)

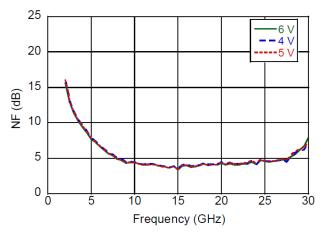


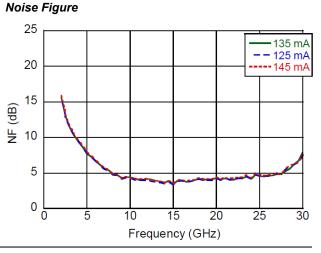
Output IP3 (10 MHz Tone Spacing, P_{IN} = -5 dBm per tone)





Noise Figure



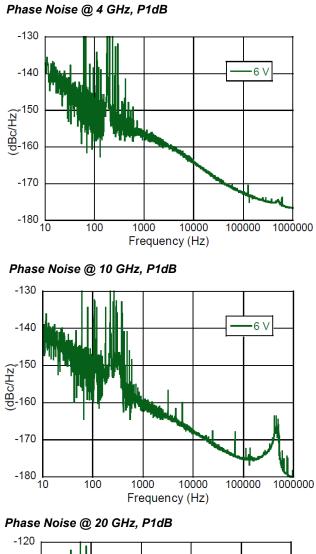


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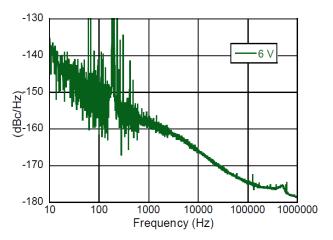


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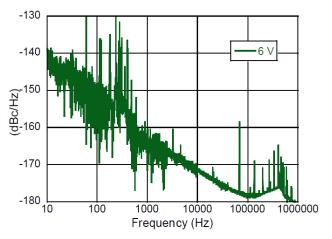




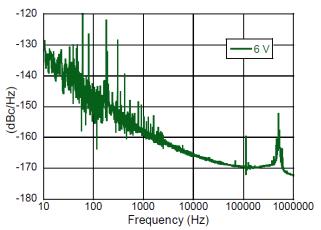
-120 -130 -140 -140 -140 -140 -150 -160 -170 -180 10 100 1000 10000 100000 Frequency (Hz) Phase Noise @ 4 GHz, P4dB



Phase Noise @ 10 GHz, P3dB







8. The aberration in the phase noise data at approximately 500 MHz is due to the test equipment used and not the amplifier itself.

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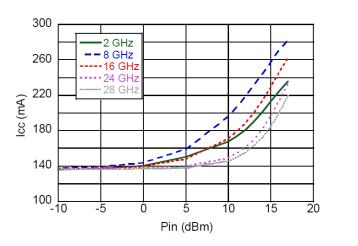


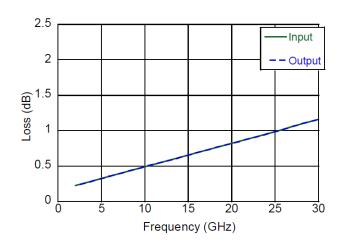
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Bias Current vs Input Power





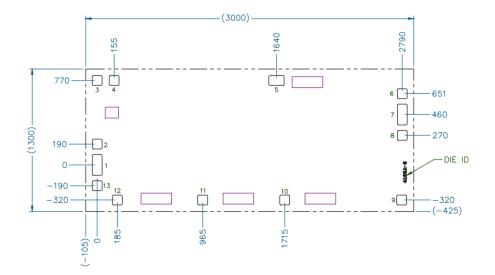


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MMIC Die Outline



BONDPAD DETAIL			
PAD	SIZE(x)	SIZE(y)	
1,7	100	200	
2,3,4,6,8,9, 10,11,12,13	100	100	
5	150	100	

- NOTES: 1. UNLESS OTHERWISE SPECIFIED, ALL DIMENSIONS SHOWN ARE μ m WITH A TOLERANCE OF $\pm 5 \mu$ m. 2. DIE THICKNESS IS 100 $\pm 10 \mu$ m 5. DOI: THICKNESS IS 100 $\pm 10 \mu$ m
- 2. 3.
- BOND/PAD BACKSIDE METALLIZATION: GOLD DIE SIZE REFLECTS FINAL DIMENSIONS. 4.



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